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电性参数

Power Dissipation	Pd	125	mw
(Continuous Forward Current)	IF	50	mA
Pulsed Forward Current (1/10Duty Cycle, 0.1msPulsewidth	IFP	200	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40 ~ +85	
Storage Temperature	Tstg	-40 ~ +85	
(Junction Temperature)	Tj	Ò115	

光电参数 Ta=25

使用注意事项（1）

Precautions (1)

贮存：

Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.

30 60%RH

Before opening the package, the product should be kept at 30 or less and humidity less than 60% RH, and be used within a year.

30 10%RH 168 7

30 60%RH

After opening the package, the product should be stored at 30 or less and humidity less than 10%RH, and be soldered within 168 hours (7 days). It is recommended that the product be operated at the workshop condition of 30 or less and humidity less than 60%RH.

LED

60 5 24

If the moisture absorbent mat

使用注意事项（2）

Precautions (2)

[redacted]

LE

A

LED

In designing a circuit, t ed

for each LED. In the mea ill

cause big current change,

It is recommended to

[redacted]

[redacted]

When handling the product, touching the encapsulant with hands will not only contaminate its surface, but also affect